



Substitute for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use as many sheets as necessary)	Complete if Known	
	Application Number	10/023720
	Filing Date	December 21, 2001
	First Named Inventor	Fitzgerald, Thomas
	Group Art Unit	3743 2825
	Examiner Name	Unknown PAUL DINH
Sheet 1 of 1		Attorney Docket No: 884.A12US1

US PATENT DOCUMENTS						
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate
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FOREIGN PATENT DOCUMENTS						
Examiner Initials *	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T ²

OTHER DOCUMENTS -- NON PATENT LITERATURE DOCUMENTS			
Examiner Initials *	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
PD		KELLY, G., et al., "Accurate Prediction of PQFP Warpage", <u>IEEE Proceedings of the Electronic Components and Technology Conference</u> , 44, Washington, (1994), 102-106	
PD		METROL, A., "Stress Analysis and Thermal Characterization of a High Pin Count PQFP", <u>Transactions of the ASME: Journal of Electronic Packaging</u> , 114, (1992), 211-220	
PD		ZHANG, X., et al., "Thermo-Mechanical Analysis for a Multi Chip Build Up Substrate Based Package", <u>Proceedings of the 2001 8th International Symposium on the Physical and Failure Analysis of Integrated Circuits. IPFA 2001 (Cat. No 01TH8548)</u> , (2001), 67-72	

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